

SE2102E**Small Signal MOSFET****20 V, 600 mA, Single N-Channel MOSFET****General Description**

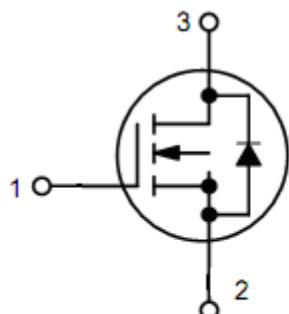
The MOSFETs from SINO-IC provide the best combination of fast switching, low on-resistance and cost-effectiveness.

Features

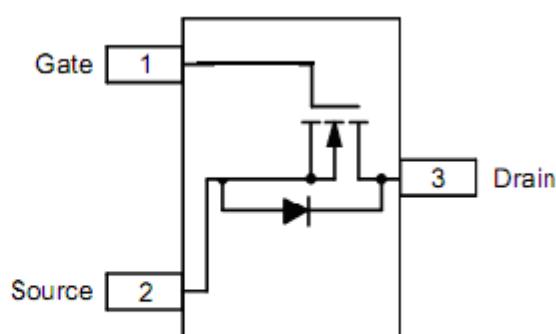
- V_{DS} (V) = 20V
- I_D = 600mA
- $R_{DS(ON)} < 350\text{m}\Omega$ ($V_{GS} = 4.5\text{V}$)
- $R_{DS(ON)} < 470\text{m}\Omega$ ($V_{GS} = 2.5\text{V}$)

Pin configurations

See Diagram below



N-Channel MOSFET



SOT-523

MAXIMUM RATINGS ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter			Symbol	Value	Units		
Drain-to-Source Voltage			V_{DSS}	20	V		
Gate-to-Source Voltage			V_{GS}	± 6.0	V		
Continuous Drain Current (Note 1)	Steady State	TA = 25°C	I_D	600	mA		
		TA = 85°C		400			
Power Dissipation (Note 1)	Steady State		P_D	170	mW		
Pulsed Drain Current	$t_p = 10 \mu\text{s}$		I_{DM}	1	A		
Operating Junction and Storage Temperature			T_J , T_{STG}	-55 to 150	°C		
Continuous Source Current (Body Diode)			I_S	250	mA		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			T_L	260	°C		

SE2102E

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	26		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0 \text{ V}, V_{DS} = 16 \text{ V}$			100	nA
Gate-to-Source Leakage Current	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1.0	μA

ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$	0.45		0.9	V
Drain-to-Source On Resistance	$R_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_D = 600 \text{ mA}$		280	350	$\text{m}\Omega$
Drain-to-Source On Resistance	$R_{DS(\text{on})}$	$V_{GS} = 2.5 \text{ V}, I_D = 500 \text{ mA}$		370	470	$\text{m}\Omega$
		$V_{GS} = 1.8 \text{ V}, I_D = 350 \text{ mA}$		650	900	
Forward Transconductance	g_{FS}	$V_{DS} = 10 \text{ V}, I_D = 400 \text{ mA}$		1.2		S

CHARGES AND CAPACITANCES

Input Capacitance	C_{ISS}	$V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz},$		130		pF
Output Capacitance	C_{OSS}		21			
Reverse Transfer Capacitance	C_{RSS}		15			
Total Gate Charge	$Q_{G(\text{TOT})}$	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}, I_D = 0.25 \text{ A}$		1.4		nC
Gate-to-Source Charge	Q_{GS}			0.35		
Gate-to-Drain Charge	Q_{GD}			0.55		

SWITCHING CHARACTERISTICS (Note 3)

Turn-On Delay Time	$t_{d(\text{ON})}$	$V_{GS} = 4.5 \text{ V}, V_{DD} = 10 \text{ V},$		6		ns
Rise Time	t_r		6			
Turn-Off Delay Time	$t_{d(\text{OFF})}$	$I_D = 0.2 \text{ A}, R_G = 10 \Omega$	25			
Fall Time	t_f		13			

DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_S = 200 \text{ mA}$	$T_J = 25^\circ\text{C}$		0.69	1.1	V
			$T_J = 1^\circ\text{C}$		0.58		

Typical Electrical Characteristics

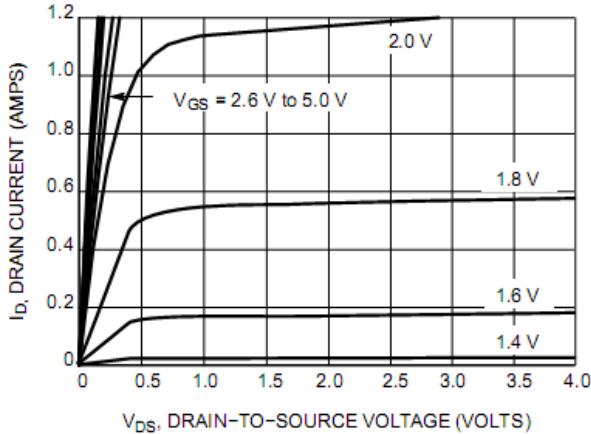


Figure 1. On-Region Characteristics

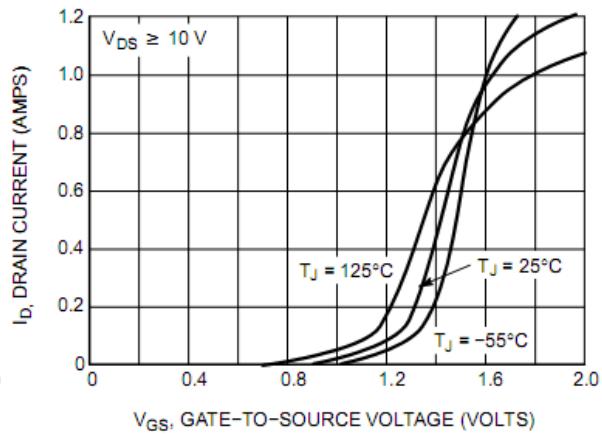


Figure 2. Transfer Characteristics

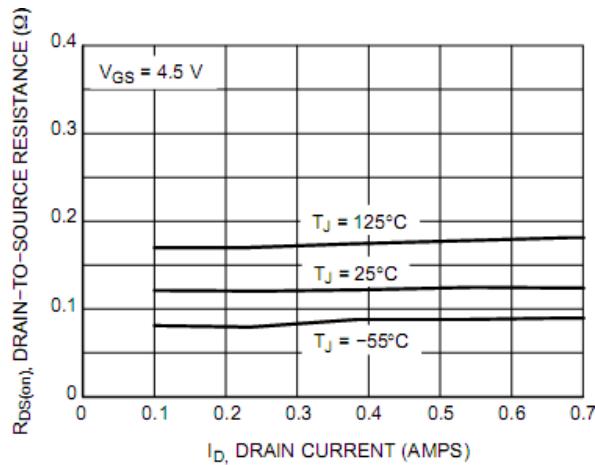


Figure 3. On-Resistance vs. Drain Current and Temperature

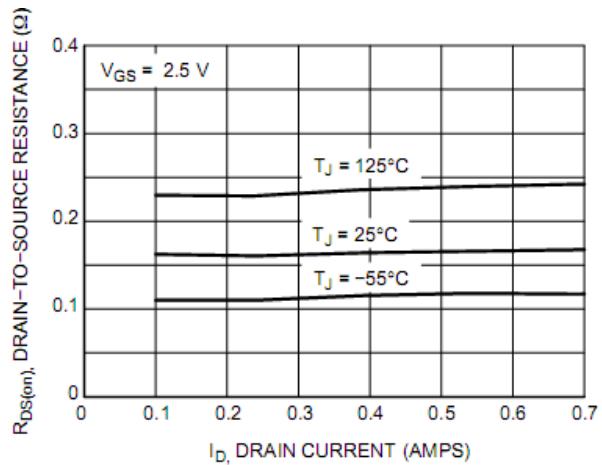


Figure 4. On-Resistance vs. Drain Current and Temperature

Typical Electrical Characteristics

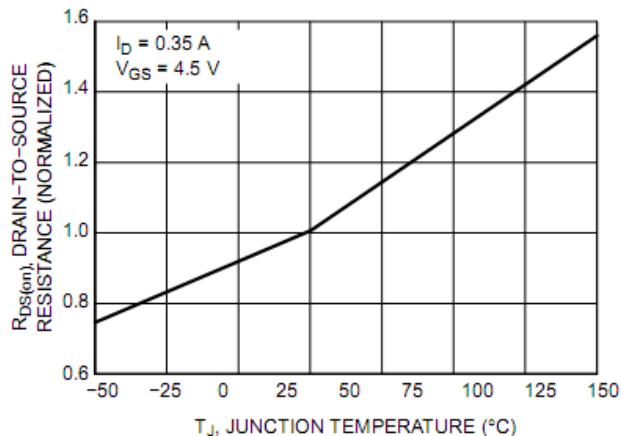


Figure 5. On-Resistance Variation with Temperature

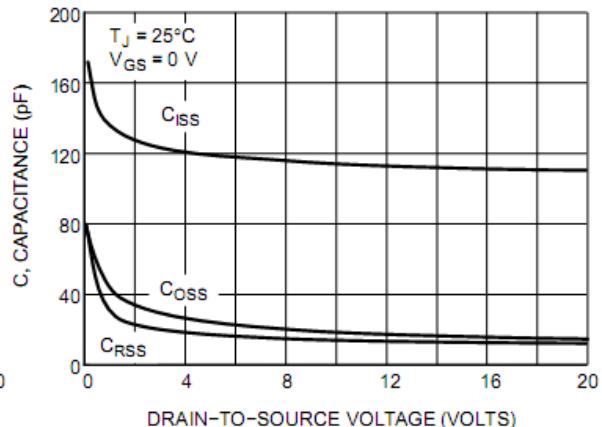


Figure 6. Capacitance Variation

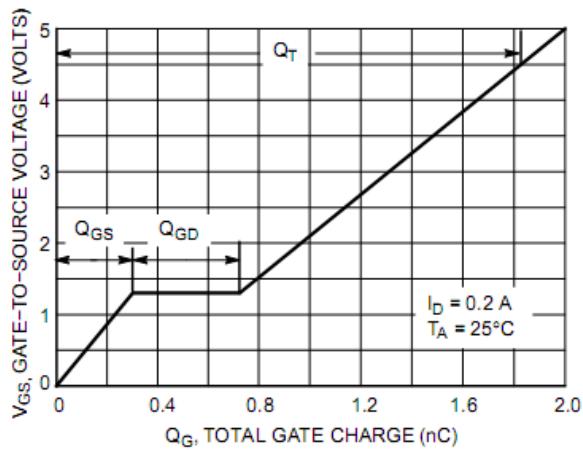


Figure 7. Gate-to-Source Voltage vs. Total Gate Charge

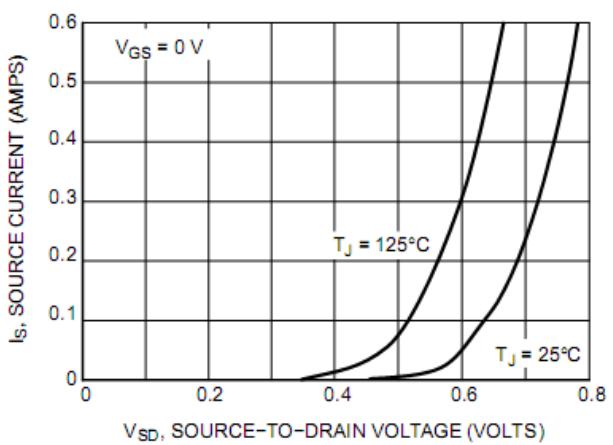


Figure 8. Diode Forward Voltage vs. Current

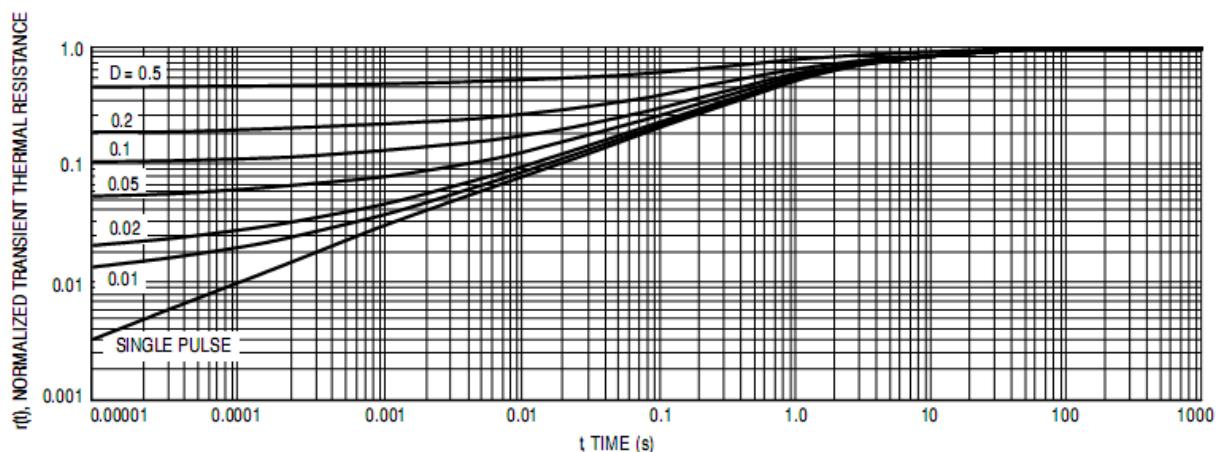
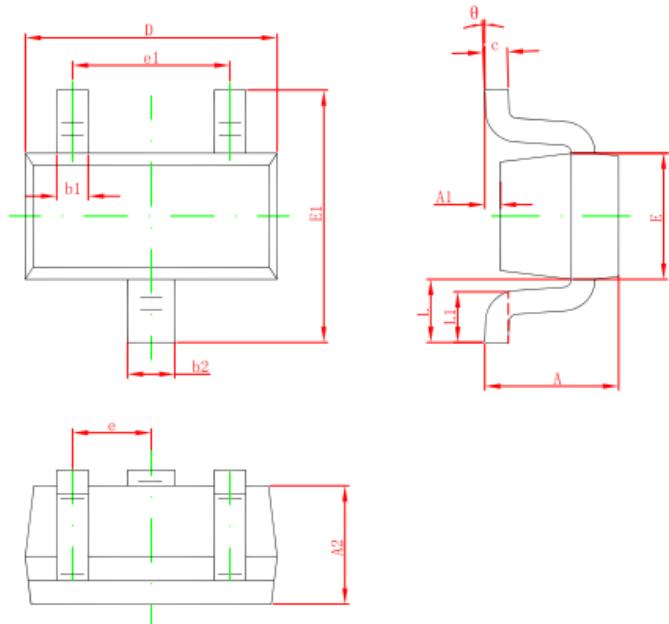


Figure 9. Normalized Thermal Response

Package Dimensions(SOT-523)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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SHANGHAI SINO-IC MICROELECTRONICS CO., LTD

Add: Building 3, Room 3401-03, No.200 Zhangheng Road, ZhangJiang Hi-Tech Park, Pudong, Shanghai 201203, China

Phone: +86-21-33932402 33932403 33932405 33933508 33933608

Fax: +86-21-33932401

Email: webmaster@sino-ic.com

Website: <http://www.sino-ic.com>